# Numerical study of mono-crystalline silicon solar cells with passivated emitter and rear contact configuration for the efficiency beyond 24% based on mass production technology

Peng Wang<sup>1, 2</sup>, Gaofei Li<sup>3, †</sup>, Miao Wang<sup>3</sup>, Hong Li<sup>3</sup>, Jing Zheng<sup>3</sup>, Liyou Yang<sup>3</sup>, Yigang Chen<sup>1</sup>, Dongdong Li<sup>2</sup>, and Linfeng Lu<sup>2, †</sup>

<sup>1</sup>School of Materials Science and Engineering, Shanghai University, Shanghai 200444, China

<sup>2</sup>CAS Key Lab of Low-Carbon Conversion Science and Engineering, Shanghai Advanced Research Institute, Chinese Academy of Sciences, Shanghai 201210, China

<sup>3</sup>Jinneng Clean Energy Limited Company, Lvliang 032100, China

**Abstract:** Mono-crystalline silicon solar cells with a passivated emitter rear contact (PERC) configuration have attracted extensive attention from both industry and scientific communities. A record efficiency of 24.06% on p-type silicon wafer and mass production efficiency around 22% have been demonstrated, mainly due to its superior rear side passivation. In this work, the PERC solar cells with a p-type silicon wafer were numerically studied in terms of the surface passivation, quality of silicon wafer and metal electrodes. A rational way to achieve a 24% mass-production efficiency was proposed. Free energy loss analyses were adopted to address the loss sources with respect to the limit efficiency of 29%, which provides a guideline for the design and manufacture of a high-efficiency PERC solar cell.

Key words: monocrystalline silicon solar cell; passivated emitter rear contact; numerical simulation; free energy loss analysis

**Citation:** P Wang, G F Li, M Wang, H Li, J Zheng, L Y Yang, Y G Chen, D D Li, and L F Lu, Numerical study of mono-crystalline silicon solar cells with passivated emitter and rear contact configuration for the efficiency beyond 24% based on mass production technology[J]. J. Semicond., 2020, 41(6), 062701. http://doi.org/10.1088/1674-4926/41/6/062701

# 1. Introduction

The first mono-crystalline silicon solar cell with passivated emitter rear contact (PERC) configuration was proposed in 1989<sup>[1]</sup>. Compared with the conventional aluminum back surface field (AI-BSF) silicon solar cell, PERC has a rear surface passivation layer such as Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub> stacked thin films and local Al-BSF contact<sup>[2]</sup>. The stacked  $Al_2O_3/SiN_x$  thin films on the rear surface effectively reduce the recombination of carriers through the combination of chemical and field passivation<sup>[3, 4]</sup>. The metal paste is in partial contact with the silicon material on the rear side, which reduces the recombination area at the metal/oxide interface and thus further improves the open circuit voltage  $(V_{OC})^{[5, 6]}$ . Consequently, the  $V_{OC}$  and short circuit current  $(J_{SC})$  of PERC are higher than that of Al-BSF solar cells, in which the rear passivation layers are absent<sup>[7]</sup>. Moreover, this partial contact design alleviates the bowing effect due to the mismatch of thermal expansion coefficients between aluminum and silicon that exists in the AI-BSF devices<sup>[8]</sup>. Although a light-induced degradation of efficiency is an important issue for PERC solar cells<sup>[9]</sup>, elaborate stabilization has recently been developed to significantly suppress the degradation<sup>[10, 11]</sup>.

In 2019, the average mass-production efficiency of ptype mono-crystalline PERC solar cells has reached around

Correspondence to: G F Li, Gaofei.Li@jinergy.com; L F Lu, lulf@sari.ac.cn Received 10 OCTOBER 2019; Revised 21 NOVEMBER 2019. ©2020 Chinese Institute of Electronics 22%, which is 1.2% higher than that of Al-BSF solar cells<sup>[12, 13]</sup>. At the beginning of 2019, LONGi Solar has announced that it has received a mono-crystalline silicon PERC laboratory efficiency at 24.06%<sup>[14]</sup>. This is the first time that the efficiency of mono-crystalline silicon PERC solar cells has exceeded 24% in commercial dimensions. This new world record and its compatibility with conventional AI-BSF product line provide a great potential of the PERC solar cell to become dominant in the upcoming market. However, there is little technical information on this achievement. In this work, a p-type mono-crystalline silicon PERC solar cell was numerically studied in terms of surface passivation of the emitter, and the quality of silicon wafer and metal electrodes, based on data from the production line and literature. A feasible way to achieve 24% efficiency of PERC solar cell using mass production technology is proposed. In addition, the efficiency loss sources between 24% and the ultimate limit of 29% are analyzed using free energy loss analysis to illustrate the space for further improvement. This is expected to provide a guideline for the design and manufacture of high efficiency mono-crystalline silicon PERC solar cells.

### 2. Device structure and simulation parameters

The PERC solar cell is simulated by Quokka 2 software, which solves the charge carrier transport in a quasi-neutral silicon device<sup>[15]</sup>. This approach employs simplifications, featuring conductive boundaries and quasi-neutrality condition to the general semiconductor carrier transport model<sup>[15]</sup>. The conductive boundary condition omits the need to solve the general set of semiconductor equations, consisting of one

#### 2 Journal of Semiconductors doi: 10.1088/1674-4926/41/6/062701



Fig. 1. (Color online) (a) A digital camera image of a PERC solar cell with five busbars from our product line. (b) Schematic illustration of the basic PERC solar cell structure in the simulation.

Table 1. Simulation parameters of PERC reference cell.		
Region	Parameter	Value
	Upright pyramids	52°, 4 μm height
Optics	Incident illumination	AM1.5g (1000 W/m <sup>2</sup> )
	Front passivation layers	15 nm SiN <sub>x</sub> ( <i>n</i> = 2.41)/70 nm SiN <sub>x</sub> ( <i>n</i> = 2.09)
	Sheet resistance	120 Ω/□
	Junction depth <sup>[20]</sup>	0.36 <i>μ</i> m
n <sup>+</sup> emitter	Non-contacted region $J_{0E}^{[20]}$	80 fA/cm <sup>2</sup>
	Contacted region $J_{0E}^{[20]}$	500 fA/cm <sup>2</sup>
	Contact resistivity <sup>[21]</sup>	2 mΩ⋅cm <sup>2</sup>
	Sheet resistance <sup>[21]</sup>	70 Ω/□
	Junction depth <sup>[21]</sup>	0.5 <i>μ</i> m
Selective emitter	Non-contacted region $J_{0E}^{[20]}$	100 fA/cm <sup>2</sup>
	Contacted region $J_{0E}^{[20]}$	500 fA/cm <sup>2</sup>
	Contact resistivity <sup>[21]</sup>	2 mΩ⋅cm <sup>2</sup>
	Cell thickness	180 μm
Bulk	Resistivity	1 Ω·cm
	Background lifetime <sup>[21]</sup>	512 μs
BSF	Sheet resistance <sup>[22]</sup>	30 Ω/□
	Junction depth	5 <i>µ</i> m
	Non-contacted region $J_{0E}^{[22]}$	13.1 fA/cm <sup>2</sup>
	Contacted region $J_{0E}^{[22]}$	795 fA/cm <sup>2</sup>
	Contact resistivity <sup>[21]</sup>	5 mΩ·cm <sup>2</sup>

transport equation for minority and majority carriers and Poisson's equation for the electric potential<sup>[15–17]</sup>. The model of charge carrier transport as described by three coupled differential equations<sup>[18]</sup> can be simplified and therefore solely solved by a set of two differential equations. These simplifications are well validated to not impose notable loss of generality or accuracy for wafer-based silicon solar cell devices<sup>[15]</sup>.

Fig. 1(a) shows a digital camera image of a PERC solar cell with five busbars from our product line. The simulation model (Fig. 1(b)) is configured based on the products. The width of simulated solar cell is 200  $\mu$ m. The solar cell features a front selective emitter (SE) configuration. The emitter is passivated with a double-layered SiN<sub>x</sub> thin films, in which the refractive index (@632 nm) and thickness of the bottom SiN<sub>x</sub> are 2.41/15 nm and the top SiN<sub>x</sub> are 2.09/70 nm, respectively. Al<sub>2</sub>O<sub>3</sub>/double-layered SiN<sub>x</sub> stacked thin films are deposited on the rear side, in which the thickness of Al<sub>2</sub>O<sub>3</sub> is 8 nm and the refractive index and thickness of SiN<sub>x</sub> are 2.03/15 nm, 1.98/135 nm, respectively. The generation profile of light to electrical carriers is simulated by Module Ray Tracer from PV Lighthouse, Sunsolve<sup>[19]</sup>.

Table 1 lists the initial parameters of the PERC reference cell, which includes the data acquired from the production line and literatures. Based on the data in Table 1, a 21.90% efficiency reference PERC solar cell is obtained by simulation, which is similar with the mass-produced efficiency as shown in Fig. 2.

## 3. Results and discussion

#### 3.1. Surface passivation of the emitters

Based on the simulated 21.90% PERC reference solar cell, potential improvements from surface passivation, silicon wafer quality and metal grid line are studied using data from the literature to pave the way for PERC solar cells beyond 24%. In PERC solar cells, the front double-layered SiN<sub>x</sub> thin films act not only as antireflection layers but also as a passivation layer. This passivation layer has a significant increase on the electrical properties of the solar cell, especially the  $V_{\rm OC}$  and  $J_{\rm SC}$ . The passivation performance is reflected by the reverse saturation current density ( $J_{\rm OE}$ ) in the simulated model. The relationship between the recombination current density ( $J_{\rm rec}$ ) and  $J_{\rm OE}$  is given by<sup>[23]</sup>



Fig. 2. The *J*–*V* curve of PERC reference cell and the electrical properties comparison between simulated and practical mass-produced PERC cell.

$$J_{\rm rec} = J_{\rm 0E} \left( \frac{np}{n_{\rm i,eff}^2 - 1} \right), \tag{1}$$

where *n* and *p* represent the concentration of electrons and holes, respectively, and  $n_{i,eff}$  represents the effective intrinsic carrier concentration. According to the Eq. (1), reducing the  $J_{0E}$  will lead a lower the  $J_{rec}$  and a better passivation performance.

In an ideal case, the relationship between  $V_{\rm OC}$ ,  $J_{\rm SC}$  and  $J_{\rm rec}$  can be expressed by<sup>[24]</sup>

$$V_{\rm OC} = \frac{KT}{q} \ln\left(1 + \frac{J_{\rm ph}}{J_{\rm rec}}\right),\tag{2}$$

$$J_{\rm SC} = J_{\rm rec} \left[ \exp\left(\frac{qv}{nKT}\right) - 1 \right] - J_{\rm ph}, \tag{3}$$

where  $J_{ph}$  is the photocurrent density, K the Boltzmann constant, T the thermodynamic temperature, q the electron charge, and v the voltage. According to the Eqs. (2) and (3), the  $V_{OC}$  and  $J_{SC}$  increase as the recombination current  $J_{rec}$  decreases. Therefore, an excellent passivation layer can effectively increase the  $V_{OC}$  and  $J_{SC}$  of the cell. In the reference cell, a double-layered SiN<sub>x</sub> having different refractive indices is selected as the front surface passivation layer based on our production line. Besides the double-layered SiN<sub>x</sub>, Huang et al. systematically studied the passivation mechanism and performance of stacked PECVD SiO<sub>x</sub>N<sub>y</sub>/SiN<sub>x</sub>, thermally grown SiO<sub>2</sub>/SiN<sub>x</sub>, thermally grown SiO<sub>2</sub>/ALD Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub> and ALD Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub><sup>[25]</sup> thin films. According to these results, the relationships between the sheet resistance of  $n^+$  emitter and the  $J_{0E}$ after passivation using these four types stacked thin films are summarized in Fig. 3<sup>[25, 26]</sup>. It is seen that the emitters with a higher sheet resistance can be passivated much better.  $SiO_2/AI_2O_3/SiN_x$  and  $SiO_2/SiN_x$  have better passivation performance than the  $SiO_xN_y/SiN_x$  and  $Al_2O_3/SiN_x$ , which delivers a  $J_{0E}$  as low as 20 fA/cm<sup>2</sup> as the sheet resistance increased to 120  $\Omega/\Box$ . The Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub> stacked film has a poor passivation performance on n<sup>+</sup> emitter due to the high effective negative charge density ( $Q_{\text{eff}} = -2.4 \times 10^{12} \text{ cm}^{-2}$ ) in Al<sub>2</sub>O<sub>3</sub><sup>[25]</sup>. This will repel photogenerated electrons and then result in depletion or weak inversion of the charge carriers under a high surface doping concentration condition<sup>[25, 27]</sup>, and in turn an increased recombination at the n<sup>+</sup> emitter. For the



Fig. 3. (Color online) The relationship between the saturation current density  $J_{0E}$  and sheet resistance of SiO<sub>x</sub>N<sub>y</sub>/SiN<sub>x</sub><sup>[26]</sup>, SiO<sub>2</sub>/SiN<sub>x</sub><sup>[25]</sup>, SiO<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub><sup>[25]</sup> and Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub><sup>[25]</sup> passivation layers on n<sup>+</sup> emitter of PERC solar cell.

SiO<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub> stacked film, the introduction of SiO<sub>2</sub> layer not only brings a low negative charge density ( $Q_{eff} = -2.1 \times 10^{11} \text{ cm}^{-2}$ ) but also results in a very low interface state density ( $D_{it} = 10^{10} \text{ eV}^{-1} \cdot \text{cm}^{-2}$ ) because of the superior ability of SiO<sub>2</sub> in passivating the dangling bonds on Si surface<sup>[28]</sup>, which is also called chemical passivation. The excellent passivation result of SiO<sub>2</sub>/SiN<sub>x</sub> stacked film ( $Q_{eff} = 2 \times 10^{11} \text{ cm}^{-2}$ ) can also be attributed to the superior chemical passivation of SiO<sub>2</sub> which is similar to SiO<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub>. The SiO<sub>x</sub>N<sub>y</sub>/SiN<sub>x</sub> stacked film ( $Q_{eff} = 1.2 \times 10^{12} \text{ cm}^{-2}$ ) has a higher interface state density ( $D_{it} = 6.1 \times 10^{11} \text{ eV}^{-1} \cdot \text{cm}^{-2}$ )<sup>[29]</sup> and so results in a poor chemical passivation compared to SiO<sub>2</sub>/SiN<sub>x</sub> stacked film<sup>[26]</sup>.

Fig. 4 compares the electrical properties of the four types of stacked films (SiO<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub>, SiO<sub>2</sub>/SiN<sub>x</sub>, SiO<sub>x</sub>N<sub>y</sub>/SiN<sub>x</sub> and Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub>) that are used in the PERC model. The thickness and refractive index of the double-layered SiN<sub>x</sub> and the simulation parameters are consistent with the reference cell, while all SiO<sub>2</sub>, SiO<sub>x</sub>N<sub>y</sub>, Al<sub>2</sub>O<sub>3</sub> in the four stacked films are 7 nm. It is seen that the V<sub>OC</sub> and FF are positive dependent on the J<sub>OE</sub>. Although a lower J<sub>OE</sub> can benefit photocurrent, the optical parasitic loss seems dominant and leads to decreased J<sub>SC</sub>. Eventually, the device using SiO<sub>2</sub>/SiN<sub>x</sub> has the highest efficiency of 22.22%, which is 0.32% higher than that of the reference cell, while the cell using Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub> has the lowest simulated efficiency of 21.35%. Therefore, in the subsequent optimization process, SiO<sub>2</sub>/SiN<sub>x</sub> stacked film is selected as the emitter passivation layer.

### 3.2. Quality of the silicon wafer

A silicon wafer with high carrier lifetime is of great benefit for improving solar cell efficiency. The carrier lifetime is inversely proportional to the recombination rate (R). The R, as a comprehensive result of Auger, radiative and Shockley-Read-Hall (SRH) recombination, which can be expressed as<sup>[24]</sup>

$$R = R_{\text{Auger}} + B_{\text{rad}}pn + R_{\text{SRH}} + \tau_{\text{b,fixed}}(n - n_0), \qquad (4)$$

where  $R_{Auger}$  is the Auger recombination rate derived from the research of Richter<sup>[30]</sup>. The radiative recombination is described by the product of hole concentration p, electron concentration n and radiative recombination coefficient  $B_{rad}$ . SRH recombination is given by<sup>[31, 32]</sup>



Fig. 4. (Color online) Comparison of (a) simulated efficiency and  $V_{OC}$ , (b) simulated  $J_{SC}$  and FF of PERC solar cells using different n<sup>+</sup> emitter passivation stacked layers.

$$R_{\rm SRH} = \frac{np - n_{\rm i,eff}^2}{\tau_{\rm p0} \left(n_1 + n\right) + \tau_{\rm n0} \left(p_1 + p\right)},$$
 (5)

where  $n_1 = n_{i,eff} \exp[(E_t - E_i)/kT]$ ,  $p_1 = n_{i,eff} \exp[-(E_t - E_i)/kT]$ ,  $E_t$ is the defect level,  $E_i$  is the intrinsic level, and  $\tau_{n0}$  and  $\tau_{p0}$  represent the lifetime of electrons and holes, respectively.  $\tau_{n0/p0} = (v_{th}\sigma N_t)^{-1}$ , where the average thermal motion rate  $v_{th} = 1.1 \times 10^7$  cm/s,  $\sigma$  is the capture section of the defect recombination center for electron/hole, and  $N_t$  is the defect concentration. The last part in the Eq. (4) represents for the recombination caused by a fixed; that is, injection independent, bulk minority carrier lifetime  $\tau_{b,fixed}$ .

In boron-doped p-type silicon wafers, the BO complex defect is an important SRH recombination center affecting carrier lifetime of the silicon wafer. Fig. 5 shows the carrier lifetime of p-type silicon wafer of varying resistivity under different conditions of BO complex activity. The intrinsic limit solid curve<sup>[33]</sup> represents the BO complex-free status while the dashed line and dotted line are the deactivated BO conditions obtained by Walter *et al.*<sup>[34]</sup> and Schmidt *et al.*<sup>[35]</sup>, respectively. It can be clearly seen that the carrier lifetime can be improved through the effective BO deactivated process.

Based on the relationship between wafer resistivity and carrier lifetime shown in Fig. 5, the electrical performance for different wafer resistivity is simulated in Fig. 6. Furthermore, in Fig. 6, the results from Refs. [33-35] are labeled as sample As, Bs and Cs, respectively. It can be seen that the efficiencies,  $V_{OC}$  and  $J_{SC}$  of all samples increase with increasing wafer resistivity over the range of 0.5–1.5  $\Omega$ -cm. When the wafer resistivity increases further,  $V_{OC}$  and  $J_{SC}$  saturate gradually for both of Bs and Cs, while efficiencies of Bs show slight decreasing and efficiencies of Cs become saturated. These trends for efficiencies,  $V_{OC}$  and  $J_{SC}$  are similar with the experimental results<sup>[36]</sup>. In contrast to the increasing trend of FF in literature 36, all of the FF results for different samples in Fig. 6 show a decreasing trend. This discrepancy can be attributed to the special injection dependence of bulk lifetime. To get the highest solar cell efficiency, the optimum value of the wafer resistivity is around 1.5  $\Omega$ ·cm. When taking the intrinsic limit lifetime (6200  $\mu$ s)<sup>[33]</sup>, the maximum efficiency of the cell is 22.19%, which is 0.29% higher than that of the reference cell. When the silicon wafer is subjected to an optimum BO deactivated process (2500  $\mu$ s)<sup>[34]</sup>, the highest efficiency of the cell is 22.13%, which is 0.23% higher than that of the reference cell. When the silicon wafer is subjected to a general BO deactiv-



Fig. 5. (Color online) Relationship between resistivity and carrier lifetime of silicon wafer under intrinsic limit condition and different BO deactivated processing conditions<sup>[29–31]</sup>.

ated process(430  $\mu$ s)<sup>[35]</sup>, the maximum efficiency of the cell is 21.85%, which is 0.05% lower than the reference cell. This indicates that a suitable BO "passivation" process is very important to achieve a high-efficiency PERC solar cell. The subsequent optimization process is based on p-type silicon wafer with the resistivity of 1.5  $\Omega$ -cm and a corresponding carrier lifetime of 2500  $\mu$ s.

#### 3.3. Metal electrodes

In the reference cell, the front grid line uses mainstream five busbars (BB) technology. The busbar width is 700  $\mu$ m, while the width and pitch size of fingers are 38 and 1600  $\mu$ m, respectively. The width of the busbars and the fingers are converted to a whole optical shading width of 57.7  $\mu$ m with a shading factor of 0.69<sup>[37]</sup>. A shading factor is used to define the effective width of fingers, which can be reduced due to the reflection into the cell through the edges of the fingers and the total internal reflection at the air/glass interface<sup>[37, 38]</sup>.

In order to further reduce the series resistance of the cell and improve efficiency, multi-busbar technology (MBB) is expected developed rapidly<sup>[39]</sup>. The increase in the number of busbars can shorten the conduction distance of the current in the fingers, which effectively reduces the resistance loss and improves the efficiency of the cell. In addition, MBB can reduce the usage amount of silver paste by greatly reducing the width of busbars<sup>[40]</sup>.

In the current industrial production of PERC solar cells, Ag paste is generally used in the front screen printing while Al paste is used on the rear side. A multilayer material with



Fig. 6. (Color online) The electrical performance of PERC solar cells varies with the resistivity of silicon wafers under intrinsic limit and different BO deactivated processing conditions<sup>[29–31]</sup>.

Table 2. Comparison of resistivity and contact resistivity of different metal electrode<sup>[21]</sup>.

Metal	Resistivity ( <i>μ</i> Ω∙cm)	Contact resistivity (mΩ·cm <sup>2</sup> )
Ag	3	2
Al	35	5
Ni/Cu	1.6	0.1

higher density and higher conductivity using nickel, copper and other metals based on the electrolysis principle is also used in the metallization scheme<sup>[41]</sup>. Compared with the traditional screen-print Ag paste, this technology can achieve a thinner grid line and a lower contact resistivity, which can effectively improve the cell efficiency. A comparison of resistivity and contact resistivity of different metal electrode is shown in Table 2.

In the simulation optimization, the front grid line of PERC adopts a 12 BB design. By calculating the total optical shading area of the metal electrodes, combined with the busbar and finger width of 300 and 38  $\mu$ m for 12 BB technology and the shading factor of 0.69<sup>[37]</sup>, the corresponding shading width is 32.6  $\mu$ m. The front metal electrode is deposited by electroplating Ni/Cu with a contact resistivity of 0.1 m $\Omega$ -cm<sup>2</sup>.

Fig. 7 summarizes the three optimization steps of the PERC solar cell. The first step is the n<sup>+</sup> emitter passivation optimization. According to different passivation layers, the cell using SiO<sub>2</sub>/SiN<sub>x</sub> has the highest simulated efficiency, followed by SiO<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub>, SiO<sub>x</sub>N<sub>y</sub>/SiN<sub>x</sub> and Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub>. When using a SiO<sub>2</sub>/SiN<sub>x</sub> passivation layer, the surface  $J_{0E}$  reaches as low as 20 fA/cm<sup>2</sup> and the cell efficiency reaches 22.22%, which is 0.32% higher than the reference cell. An optimized bulk resistivity of 1.5  $\Omega$ ·cm is obtained in the second step. The star, rhombic and circle in step (2) are electrical parameters that are based on silicon wafers with carrier lifetimes of 6200, 2500 and 430  $\mu$ s, respectively, which are described in Fig. 4. When the carrier lifetime is taken as 6200  $\mu$ s, the simulation efficiency of the cell is 23.13%, which is considered as the limiting efficiency in this step. When the carrier lifetime is 2500  $\mu$ s, the simulation efficiency of the cell is 22.98%. The third step is the optimization of the metal electrodes based on a carrier lifetime of 2500  $\mu$ s. The hollow stars represent the 23.76% efficiency based on the 12 BB technology by which the shading width reduces from 57.7 to 32.6  $\mu$ m. If the screen-print Ag paste is furtherly replaced by the electroplated Ni/Cu electrode with lower contact resistivity of 0.1 m $\Omega$ -cm<sup>2</sup> and width of 32.6  $\mu$ m, the efficiency can be improved to 24.04% thanks to the significant improvement of FF of up to 81.24%, while the  $V_{OC}$  and  $J_{SC}$  remain constant. These results are represented by solid hollow stars, as shown in Fig. 7.

Based on the free energy loss analysis (FELA) simulation, Fig. 8 shows the analysis of the efficiency loss sources of PERC solar cell between the efficiency of 24.04% and the ultimate limit efficiency of 29% based on the Shockley-Queisser model<sup>[42-44]</sup>. The recombination loss is the largest (2.73%), followed by the optical loss (1.42%), and finally the ohmic loss (0.81%). Further analysis has found that the individual loss due to the recombination of SRH and intrinsic carriers in the silicon wafer is the largest (0.61%), followed by the individual loss from surface reflection (0.54%), and then from parasitic absorption (0.51%). These individual losses sum up to an efficiency of 27.51% rather than to the ultimate limit of 29%. The rest efficiency gap is due to the synergistic effect that the increase of  $J_{SC}$  will result in increasing  $V_{OC}$ , and hence will increase the efficiency. The synergistic efficiency enhancement over the whole ohmic improvements and optical improvements are only 0.03% and 0.18%, respectively, while the synergistic efficiency enhancement over the whole recombination improvements is as high as 1.49%.

# 4. Conclusion

A reference PERC solar cell with 21.90% efficiency is obtained from numerical simulation based on the data from the



Fig. 7. (Color online) Simulated solar cell of a possible scenario for further PERC cell improvements. In step (1), the star, triangle, circle and rhombus points represent cells with SiO<sub>2</sub>/SiN<sub>x</sub>, SiO<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub>, SiO<sub>x</sub>N<sub>y</sub>/SiN<sub>x</sub> and Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub>, respectively. In step (2), the star, rhombus and circle points represent carrier lifetimes of 6200, 2500, and 430  $\mu$ s, respectively. In step (3), the hollow star represents the cell with 12 BB and the solid star represents the cell using 12 BB together with Ni/Cu electrode.



Fig. 8. (Color online) Sources of the efficiency loss between the simulated PERC solar cell with 24.04% to the limit efficiency of 29%.

production line. Its electrical properties are well coincided with that of the practical solar cell. Based on the reference cell, the performance as a function of surface passivation, quality of silicon wafer and metal electrodes was systematically discussed. By comparing the passivation layers, SiO<sub>2</sub>/SiN<sub>x</sub> stacked thin films are considered to be the best candidates for the passivation of n<sup>+</sup> emitters because of their low optical parasitic loss and excellent passivation properties. By considering both the passivation of BO complex and the relationship between resistivity and minority carrier lifetime, silicon wafers with resistivity of 1.5  $\Omega$ -cm and carrier lifetime of 2500  $\mu$ s are preferred. For metal electrodes, the 12 BB technology and Ni/Cu electrode are employed with an optimal shading width of 32.6  $\mu$ m and contact resistivity of 0.1 m $\Omega$ -cm<sup>2</sup>. Finally, a PERC model with an efficiency of 24.04% is obtained. In addition, an analysis of the efficiency loss sources from the 24.04% simulated efficiency to the 29% ultimate limit of PERC solar cell is performed. It can be seen that there is still much room for optimization in terms of surface reflection loss, absorption loss and SRH recombination loss. Therefore, this work is expected to give a guideline for the design and manufacture of high-efficiency PERC solar cells.

#### Acknowledgments

This work was supported by the National Natural Science Foundation of China (No. 61504155).

# References

- Blakers A W, Wang A, Milne A M, et al. 22.8% efficient silicon solar cell. Appl Phys Lett, 1989, 55(13), 1363
- [2] Joonwichien S, Utsunomiya S, Kida Y, et al. Improved rear local contact formation using AI paste containing Si for industrial PERC solar cell. IEEE J Photovolt, 2018, 8(1), 54
- [3] Albadri A M. Characterization of Al<sub>2</sub>O<sub>3</sub> surface passivation of silicon solar cells. TSF, 2014, 562, 451
- [4] Pawlik M, Vilcot J P, Halbwax M, et al. Electrical and chemical studies on Al<sub>2</sub>O<sub>3</sub> passivation activation process. Energy Procedia, 2014, 60, 85
- [5] Inns D, Poplavskyy D. Measurement of metal induced recombination in solar cells. IEEE 42nd Photovoltaic Specialist Conference (PVSC), 2015, 1
- [6] Inns D. Understanding metal induced recombination losses in silicon solar cells with screen printed silver contacts. Energy Procedia, 2016, 98, 23
- [7] Chen N, Ebong A. Towards 20% efficient industrial AI-BSF silicon solar cell with multiple busbars and fine gridlines. Sol Energy Mater Sol Cells, 2016, 146, 107
- [8] Urueña A, John J, Eyben P, et al. Studying local aluminum back surface field (AI-BSF) contacts through scanning spreading resistance microscopy (SSRM). 26th European Photovoltaic Solar Energy Conference (EU PVSEC), 2011
- [9] Hallam B, Herguth A, Hamer P, et al. Eliminating light-induced degradation in commercial p-type Czochralski silicon solar cells. Appl Sci, 2018, 8(1), 10
- [10] Herguth A, Hahn G. Kinetics of the boron-oxygen related defect in theory and experiment. J Appl Phys, 2010, 108(11), 114509
- [11] Herguth A, Schubert G, Kaes M, et al. Avoiding boron-oxygen related degradation in highly boron doped Cz silicon. 21st European Photovoltaic Solar Energy Conference (EU PVSEC), 2006, 530
- [12] Ye F, Deng W, Guo W, et al. 22.13% efficient industrial p-type mono PERC solar cell. IEEE 43rd Photovoltaic Specialists Conference (PVSC), 2016, 3360
- [13] Müller M, Fischer G, Bitnar B, et al. Loss analysis of 22% efficient industrial PERC solar cells. Energy Procedia, 2017, 124, 131
- [14] LONGi Solar sets new bifacial mono-PERC solar cell world record at 24.06 percent. https://www.prnewswire.com/in/news-releases/longi-solar-sets-new-bifacial-mono-perc-solar-cell-worldrecord-at-24-06-percent-875820879.html
- [15] Fell A. A free and fast three-dimensional/two-dimensional solar cell simulator featuring conductive boundary and quasi-neutrality approximations. IEEE Trans Electron Devices, 2013, 60(2), 733
- [16] Del Alamo J A, Swanson R M. The physics and modeling of heavily doped emitters. IEEE Trans Electron Devices, 1984, 31(12), 1878
- [17] Swanson R M J S C. Point-contact solar cells: modeling and experiment. Sol Cells, 1986, 17(1), 85
- [18] Brendel R. Modeling solar cells with the dopant-diffused layers treated as conductive boundaries. Prog Photovolt: Res Appl, 2012, 20(1), 31
- [19] Module ray tracer from PV lighthouse, sunsolve. https://www.pv-lighthouse.com.au/sunsolve
- [20] Fell A, Mcintosh K R, Altermatt P P, et al. Input parameters for the simulation of silicon solar cells in 2014. IEEE J Photovolt, 2017, 5(4), 1250
- [21] Min B, Müller M, Wagner H, et al. A roadmap toward 24% efficient PERC solar cells in industrial mass production. IEEE J Photovolt, 2017, 7(6), 1541
- [22] Ernst M, Walter D, Fell A, et al. Efficiency potential of p-type Al pas-

sivated perc solar cells with locally laser-doped rear contacts. IEEE J Photovolt, 2016, 6(3), 1

- [23] Shockley W. The theory of p-n junctions in semiconductors and p-n junction transistors. Bell Syst Tech J, 1949, 28(3), 435
- [24] Würfel P. Physics of solar cells: from principles to new concepts. Berlin: Wiley-vch, 2005
- [25] Huang H, Modanese C, Sun S, et al. Effective passivation of p<sup>+</sup> and n<sup>+</sup> emitters using SiO<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/SiN<sub>x</sub> stacks: Surface passivation mechanisms and application to industrial p-PERT bifacial Si solar cells. Sol Energy Mater Sol Cells, 2018, 186, 356
- [26] Kimmerle A, Rahman M M, Werner S, et al. Precise parameterization of the recombination velocity at passivated phosphorus doped surfaces. J Appl Phys, 2016, 119(2), 025706
- [27] Dingemans G, Kessels W. Status and prospects of Al<sub>2</sub>O<sub>3</sub>-based surface passivation schemes for silicon solar cells. J Vac Sci Technol A, 2012, 30(4), 040802
- [28] Glunz S W, Feldmann F. SiO<sub>2</sub> surface passivation layers–a key technology for silicon solar cells. Sol Energy Mater Sol Cells, 2018, 185, 260
- [29] Zhuo Z, Sannomiya Y, Kanetani Y, et al. Interface properties of Si-O<sub>x</sub>N<sub>y</sub> layer on Si prepared by atmospheric-pressure plasma oxidation-nitridation. Nanoscale Res Lett, 2013, 8(1), 201
- [30] Richter A, Glunz S W, Werner F, et al. Improved quantitative description of Auger recombination in crystalline silicon. Phys Rev B, 2012, 86(16), 4172
- [31] Shockley W, Read W Jr. Statistics of the recombinations of holes and electrons. Phys Rev, 1952, 87(5), 835
- [32] Hall R. Germanium rectifier characteristics. Phys Rev, 1951, 83(1), 228
- [33] Richter A, Werner F, Cuevas A, et al. Improved parameterization of Auger recombination in silicon. Energy Procedia, 2012, 27(27), 88
- [34] Walter D C, Lim B, Schmidt J. Realistic efficiency potential of nextgeneration industrial Czochralski-grown silicon solar cells after deactivation of the boron–oxygen-related defect center. Prog Photovolt: Res Appl, 2016, 24(7), 920
- [35] Schmidt J, Lim B, Walter D, et al. Impurity-related limitations of next-generation industrial silicon solar cells. IEEE J Photovolt, 2013, 3(1), 114
- [36] Wolny F, Weber T, Müller M, et al. Light induced degradation and regeneration of high efficiency Cz PERC cells with varying base resistivity. Energy Procedia, 2013, 38, 523
- [37] Woehl R, Hörteis M, Glunz S. Analysis of the optical properties of screen-printed and aerosol-printed and plated fingers of silicon solar cells. Adv OptoElectron, 2008, 759340
- [38] Blakers A. Shading losses of solar-cell metal grids. J Appl Phys, 1992, 71(10), 5237
- [39] Braun S, Micard G, Hahn G. Solar cell improvement by using a multi busbar design as front electrode. Energy Procedia, 2012, 27(7), 227
- [40] Walter J, Tranitz M, Volk M, et al. Multi-wire interconnection of busbar-free solar cells. Energy Procedia, 2014, 55, 380
- [41] Rehman A U, Lee S H. Review of the potential of the Ni/Cu plating technique for crystalline silicon solar cells. Materials, 2014, 7(2), 1318
- [42] Shockley W, Queisser H J. Detailed balance limit of efficiency of p-n junction solar cells. J Appl Phys, 1961, 32(3), 510
- [43] Kerr M J, Cuevas A, Campbell P. Limiting efficiency of crystalline silicon solar cells due to Coulomb-enhanced Auger recombination. Prog Photovolt: Res Appl Math, 2003, 11(2), 97
- [44] Richter A, Hermle M, Glunz S W. Reassessment of the limiting efficiency for crystalline silicon solar cells. IEEE J Photovolt, 2013, 3(4), 1184